

04-12-2002

ASSIG



HEET

102053807



To: Honorable Commissioner of Patents and Trademarks

04/04/02

Please record the attached original document or copy thereof

- 1. Name of conveying parties:
 - a) Ross Stenfort
 - b) Tianshu Chi
- 2. Name and address of receiving party:
 - a) Name: Adaptec, Inc.
 - b) Address: 691 South Milpitas Blvd., Milpitas, CA 95035
- 3. Nature of conveyance

<input checked="" type="checkbox"/> Assignment	<input type="checkbox"/> Merger
<input type="checkbox"/> Security Agreement	<input type="checkbox"/> Change of Name
<input type="checkbox"/> Other _____	<input type="checkbox"/> License Agreement

Execution Dates:

- a) April 4, 2002
- b) April 4, 2002

4. Application Number: [to be assigned]

The title of the new application is: **SYSTEM AND METHOD FOR DETERMINING INTEGRATED CIRCUIT LOGIC SPEED**

5. Please send all correspondence concerning this document to:



Joe A. Brock, II, Esq.
 MARTINE & PENILLA, LLP
 710 Lakeway Drive, Suite 170
 Sunnyvale, CA 94085
Customer Number 25920
 Tel. No. (408) 749-6900
 Fax No.: (408) 749-6901

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- Enclosed
- Commissioner is authorized to charge any deficiencies to Deposit Account No. 50-0805 (Order No. ADAPP231)

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: April 4, 2002

 Joe A. Brock, II, Esq.
 Reg. No. 46,021

ASSIGNMENT OF PATENT APPLICATION

(Accompanying Application)

Whereas we the undersigned inventors have invented certain new and useful improvements as set forth in the patent application entitled:

SYSTEM AND METHOD FOR DETERMINING INTEGRATED CIRCUIT LOGIC SPEED

(Atty. Docket No: ADAPP231) for which we have executed an application for a United States Letters Patent.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we the undersigned inventors hereby:

- 1) Sell, assign and transfer to Adaptec, Inc., a Delaware corporation having a place of business at 691 S. Milpitas Blvd., Milpitas, CA 95035, (hereinafter referred to as "ASSIGNEE"), the entire right title and interest in any and all improvements and inventions disclosed in, applications based upon, and Patents (including foreign patents) granted upon the information which is disclosed in the above referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division, continuation, substitute or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon the inventors, as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the dates indicated beside our signatures.

- | | | |
|----|---------------------------------|---------------------|
| 1) | Signature: <u>Ross Stenfort</u> | Date: <u>4/4/02</u> |
| | Typed Name: Ross Stenfort | |
| 2) | Signature: <u>Tianshu Chi</u> | Date: <u>4/4/02</u> |
| | Typed Name: Tianshu Chi | |